

Low power JFET quad operational amplifier

Datasheet — production data

Features

- Very low power consumption: 200 μA
- Wide common-mode (up to V_{CC}^+) and differential voltage ranges
- Low input bias and offset currents
- Output short-circuit protection
- High input impedance JFET input stage
- Internal frequency compensation
- Latch up free operation
- High slew rate: 3.5 V/ μs

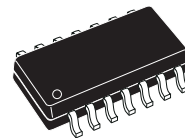
Description

The TL064, TL064A and TL064B are high-speed JFET input single operational amplifiers. Each of these JFET input operational amplifiers incorporates well matched, high-voltage JFET and bipolar transistors in a monolithic integrated circuit.

The devices feature high slew rates, low input bias and offset currents, and low offset voltage temperature coefficient.

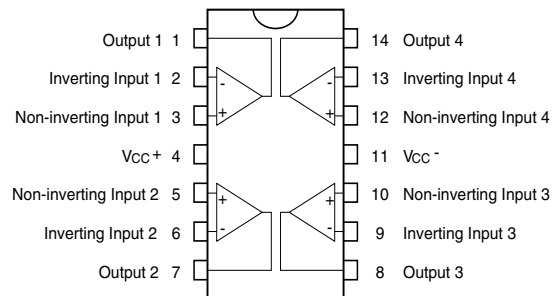


N
DIP14
(Plastic package)



D
SO-14
(Plastic micropackage)

Pin connections (Top view)



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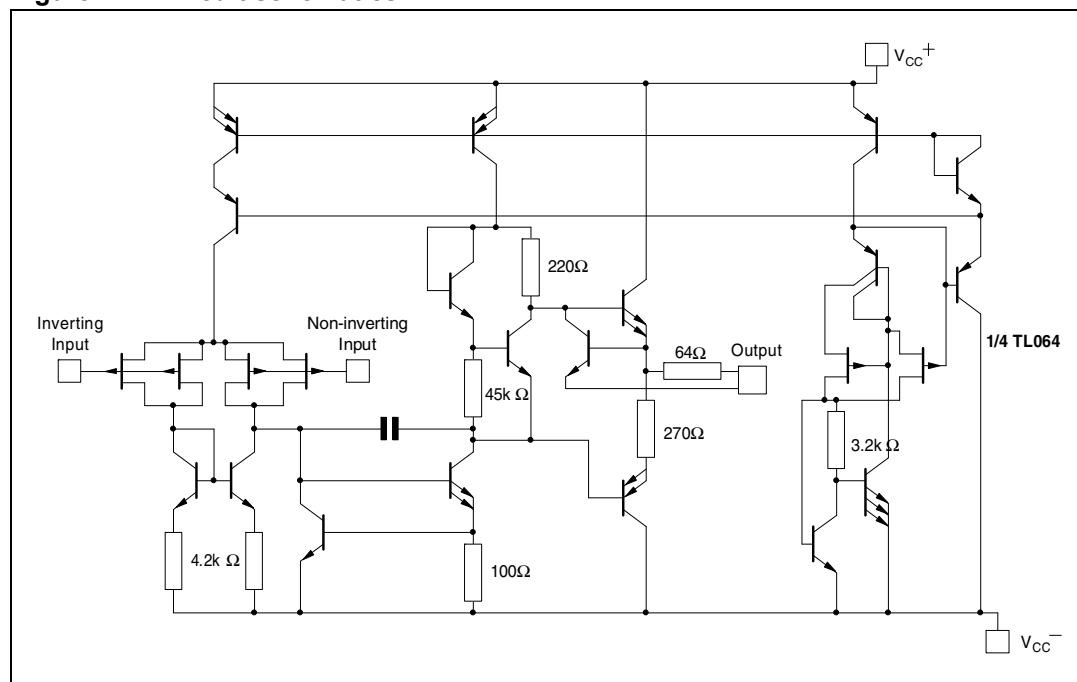
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1 Schematic diagram

Figure 1. Circuit schematics



2 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage ⁽¹⁾	± 18	V
V_i	Input voltage ⁽²⁾	± 15	
V_{id}	Differential input voltage ⁽³⁾	± 30	
P_{tot}	Power dissipation	680	mW
R_{thja}	Thermal resistance junction to ambient ⁽⁴⁾⁽⁵⁾ DIP14	80	°C/W
	SO-14	105	
R_{thjc}	Thermal resistance junction to case ⁽⁴⁾⁽⁵⁾ DIP14	33	
	SO-14	31	
	Output short-circuit duration ⁽⁶⁾	Infinite	
T_{stg}	Storage temperature range	-65 to +150	°C
ESD	HBM: human body model ⁽⁷⁾	900	V
	MM: machine model ⁽⁸⁾	200	
	CDM: charged device model ⁽⁹⁾	1500	

1. All voltage values, except differential voltage, are with respect to the zero reference level (ground) of the supply voltages where the zero reference level is the midpoint between V_{CC}^+ and V_{CC}^- .
2. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 volts, whichever is less.
3. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
4. Short-circuits can cause excessive heating and destructive dissipation.
5. R_{th} are typical values.
6. The output may be shorted to ground or to either supply. Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.
7. Human body model: 100pF discharged through a 1.5k Ω resistor between two pins of the device, done for all couples of pin combinations with other pins floating.
8. Machine model: a 200pF cap is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω), done for all couples of pin combinations with other pins floating.
9. Charged device model: all pins plus package are charged together to the specified voltage and then discharged directly to the ground.

Table 2. Operating conditions

Product	Supply voltage range (V)	Operating free-air temperature range (°C)
TL064C TL064AC TL064BC	6 to 36	0 to +70
TL064I TL064AI TL064BI		-40 to +105
TL064M TL064AM TL064BM		-55 to +125

3 Electrical characteristics

Table 3. $V_{CC} = \pm 15\text{ V}$, $T_{amb} = +25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	TL064M			TL064I			TL064C			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
V_{io}	Input offset voltage ($R_S = 50\ \Omega$) $T_{min} \leq T_{amb} \leq T_{max}$		3	6 15		3	6 9		3	15 20	mV
$\Delta V_{io}/\Delta T$	Temperature coefficient of input offset voltage ($R_S = 50\ \Omega$)		10			10			10		$\mu\text{V}/^\circ\text{C}$
I_{io}	Input offset current ⁽¹⁾ $T_{min} \leq T_{amb} \leq T_{max}$		5	100 20		5	100 10		5	200 5	pA nA
I_{ib}	Input bias current ⁽¹⁾ $T_{min} \leq T_{amb} \leq T_{max}$		30	200 50		30	200 20		30	400 10	pA nA
V_{icm}	Input common mode voltage range $T_{min} \leq T_{amb} \leq T_{max}$	± 11.5	+15 -12		± 11.5	+15 -12		± 11	+15 -12		V
V_{opp}	Output voltage swing ($R_L = 10\ \text{k}\Omega$) $T_{min} \leq T_{amb} \leq T_{max}$	20 20	27		20 20	27		20 20	27		
A_{vd}	Large signal voltage gain ($R_L = 10\ \text{k}\Omega$, $V_o = \pm 10\ \text{V}$) $T_{min} \leq T_{amb} \leq T_{max}$	4 4	6		4 4	6		3 3	6		V/mV
GBP	Gain bandwidth product ($R_L = 10\ \text{k}\Omega$, $C_L = 100\ \text{pF}$)		1			1			1		MHz
R_i	Input resistance		10^{12}			10^{12}			10^{12}		Ω
CMR	Common mode rejection ratio ($R_S = 50\ \Omega$)	80	86		80	86		70	76		dB
SVR	Supply voltage rejection ratio ($R_S = 50\ \Omega$)	80	95		80	95		70	95		
I_{CC}	Supply current, (per amplifier, no load, no signal)		200	250		200	250		200	250	μA
V_{01}/V_{02}	Channel separation ($A_V = 100$)		120			120			120		dB
P_D	Total power consumption (no load, no signal)		6	7.5		6	7.5		6	7.5	mW
SR	Slew rate ($A_V = 1$, $V_i = 10\ \text{V}$, $R_L = 10\ \text{k}\Omega$, $C_L = 100\ \text{pF}$)	1.5	3.5		1.5	3.5		1.5	3.5		V/ μs
t_r	Rise time ($A_V = 1$, $V_i = 20\ \text{mV}$, $R_L = 10\ \text{k}\Omega$, $C_L = 100\ \text{pF}$)		0.2			0.2			0.2		μs
K_{ov}	Overshoot factor ($A_V = 1$, $V_i = 20\ \text{mV}$, $R_L = 10\ \text{k}\Omega$, $C_L = 100\ \text{pF}$, see Figure 2)		10			10			10		%
e_n	Equivalent input noise voltage ($R_S = 100\ \Omega$, $f = 1\ \text{kHz}$)		42			42			42		$\frac{\text{nV}}{\sqrt{\text{Hz}}}$

1. The input bias currents of a FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive. Pulse techniques must be used that will maintain the junction temperature as close to the ambient temperature as possible.

Table 4. $V_{CC} = \pm 15\text{ V}$, $T_{amb} = +25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	TL064AM, AI, AC			TL064BM, BI, BC			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	
V_{io}	Input offset voltage ($R_S = 50\ \Omega$) $T_{min} \leq T_{amb} \leq T_{max}$		3	6 7.5		2	3 5	mV
$\Delta V_{io}/\Delta T$	Temperature coefficient of input offset voltage ($R_S = 50\ \Omega$)		10			10		$\mu\text{V}/^\circ\text{C}$
I_{io}	Input offset current ⁽¹⁾ $T_{min} \leq T_{amb} \leq T_{max}$		5	100 3		5	100 3	pA nA
I_{ib}	Input bias current ⁽¹⁾ $T_{min} \leq T_{amb} \leq T_{max}$		30	200 7		30	200 7	pA nA
V_{icm}	Input common mode voltage range $T_{min} \leq T_{amb} \leq T_{max}$	± 11.5	+15 -12		± 11.5	+15 -12		V
V_{opp}	Output voltage swing ($R_L = 10\ \text{k}\Omega$) $T_{min} \leq T_{amb} \leq T_{max}$	20 20	27		20 20	27		
A_{vd}	Large signal voltage gain ($R_L = 10\ \text{k}\Omega$, $V_o = \pm 10\text{ V}$) $T_{min} \leq T_{amb} \leq T_{max}$	4 4	6		4 4	6		V/mV
GBP	Gain bandwidth product ($R_L = 10\ \text{k}\Omega$, $C_L = 100\ \text{pF}$)		1			1		MHz
R_i	Input resistance		10^{12}			10^{12}		Ω
CMR	Common mode rejection ratio ($R_S = 50\ \Omega$)	80	86		80	86		dB
SVR	Supply voltage rejection ratio ($R_S = 50\ \Omega$)	80	95		80	95		dB
I_{CC}	Supply current (per amplifier, no load, no signal)		200	250		200	250	μA
V_{01}/V_{02}	Channel separation ($A_V = 100$)		120			120		dB
P_D	Total power consumption (each amplifier, no load, no signal)		6	7.5		6	7.5	mW
SR	Slew rate ($A_V = 1$, $V_i = 10\text{ V}$, $R_L = 10\ \text{k}\Omega$, $C_L = 100\ \text{pF}$)	1.5	3.5		1.5	3.5		V/ μs
t_r	Rise time ($A_V = 1$, $V_i = 20\text{ mV}$, $R_L = 10\ \text{k}\Omega$, $C_L = 100\ \text{pF}$)		0.2			0.2		μs
K_{ov}	Overshoot factor ($A_V = 1$, $V_i = 20\text{ mV}$, $R_L = 10\ \text{k}\Omega$, $C_L = 100\ \text{pF}$, see Figure 2)		10			10		%
e_n	Equivalent input noise voltage ($R_S = 100\ \Omega$, $f = 1\ \text{KHz}$)		42			42		$\frac{\text{nV}}{\sqrt{\text{Hz}}}$

1. The input bias currents of an FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive. Pulse techniques must be used that will maintain the junction temperature as close to the ambient temperature as possible.

Figure 2. Maximum peak-to-peak output voltage versus supply voltage

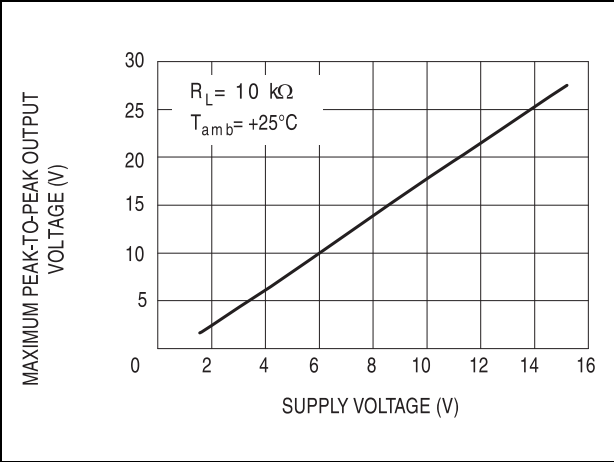


Figure 3. Maximum peak-to-peak output voltage versus free air temp

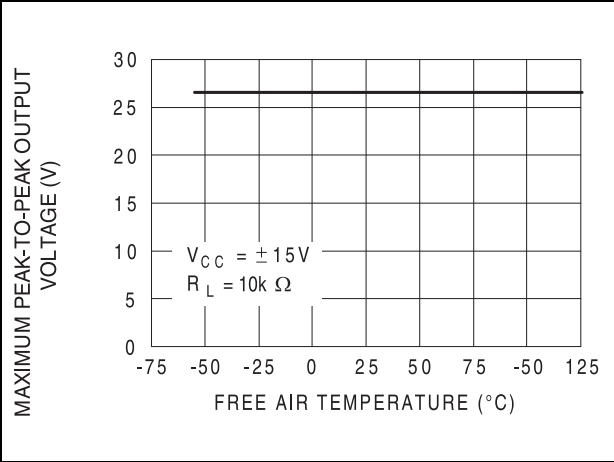


Figure 4. Maximum peak-to-peak output voltage versus load resistance

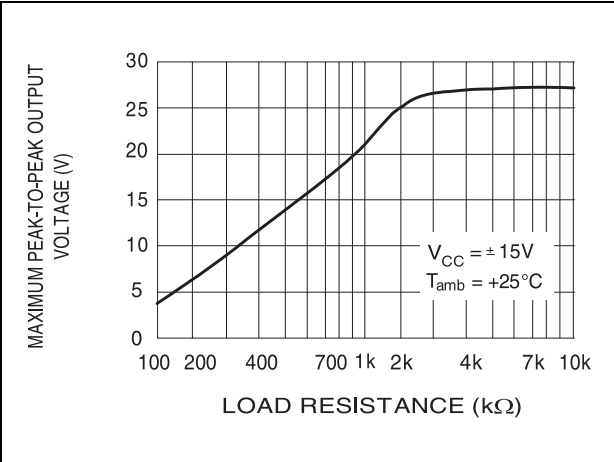


Figure 5. Maximum peak-to-peak output voltage versus frequency

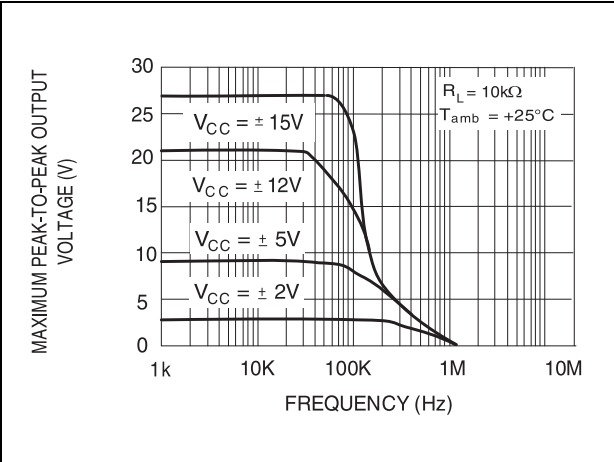


Figure 6. Differential voltage amplification versus free air temperature

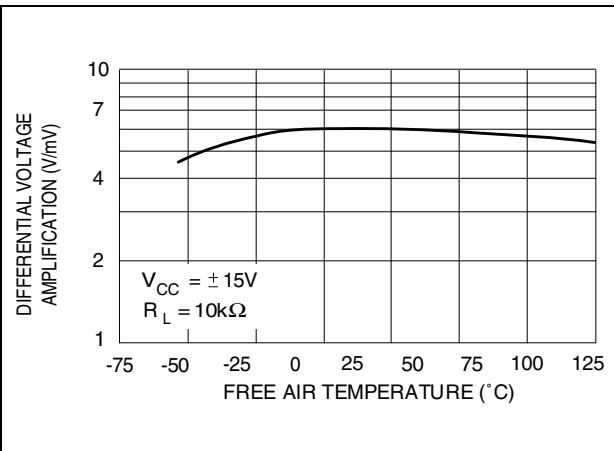


Figure 7. Large signal differential voltage amplification and phase shift versus frequency

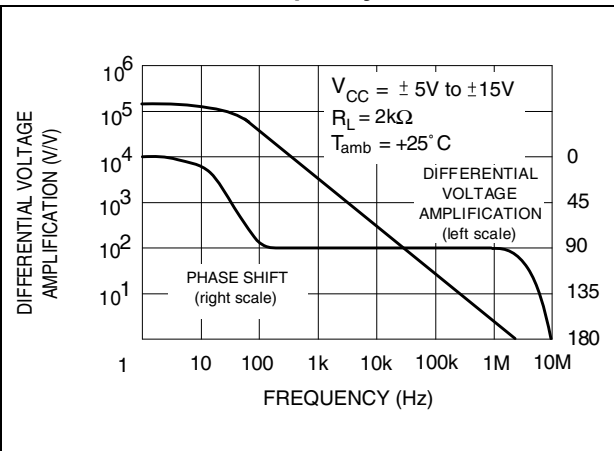


Figure 8. Supply current per amplifier versus supply voltage

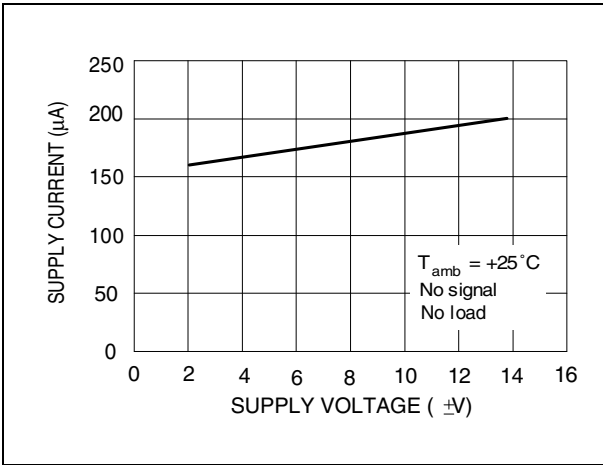


Figure 9. Supply current per amplifier versus free air temperature

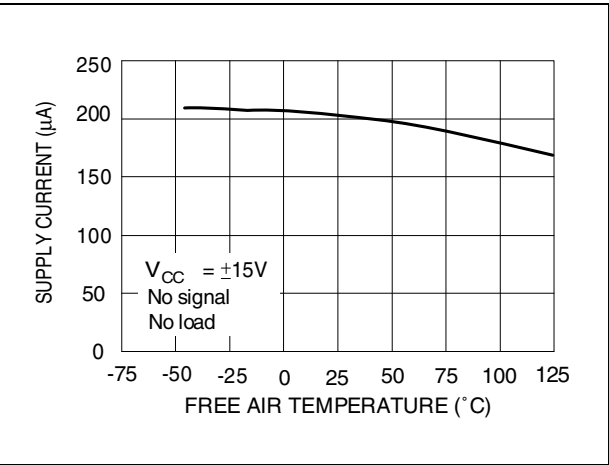


Figure 10. Total power dissipated versus free air temperature

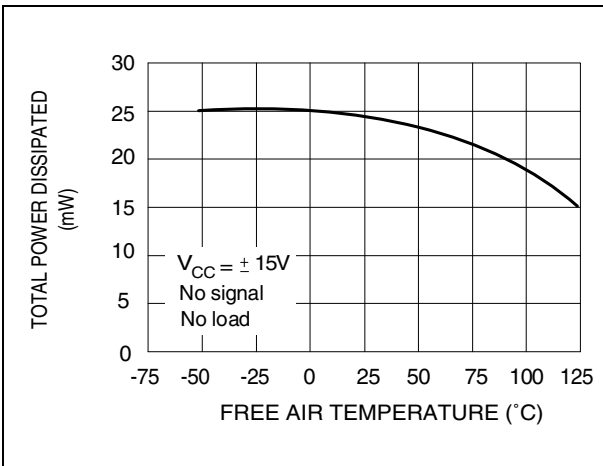


Figure 11. Common mode rejection ratio versus free air temperature

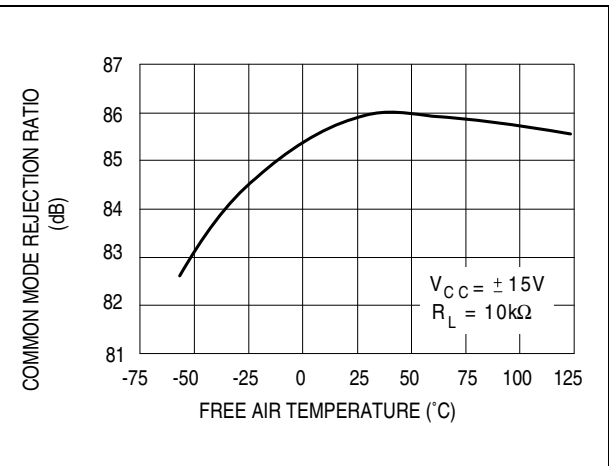


Figure 12. Normalized unity gain bandwidth, slew rate, and phase shift versus temperature

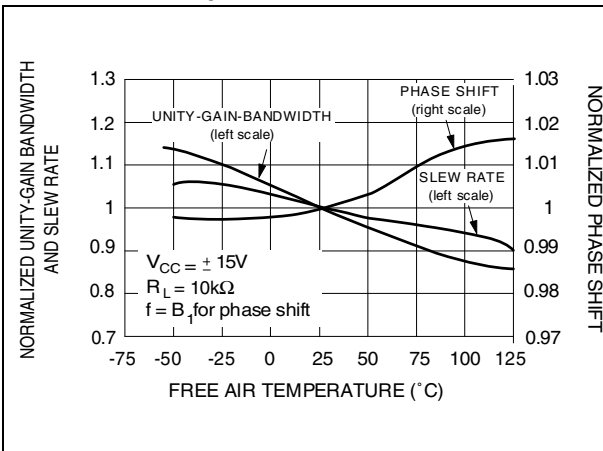


Figure 13. Input bias current versus free air temperature

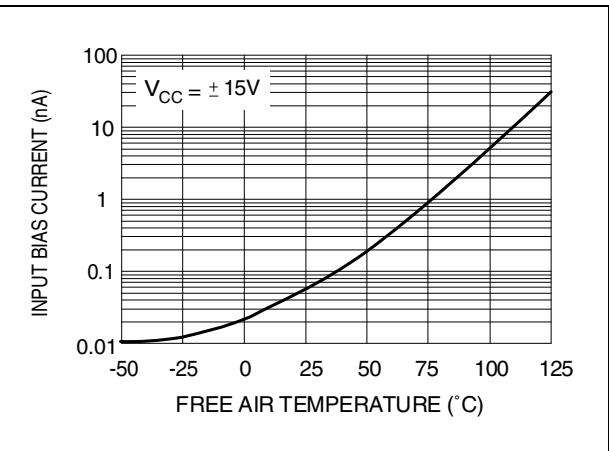


Figure 14. Voltage follower large signal pulse response Figure 15. Output voltage versus elapsed time

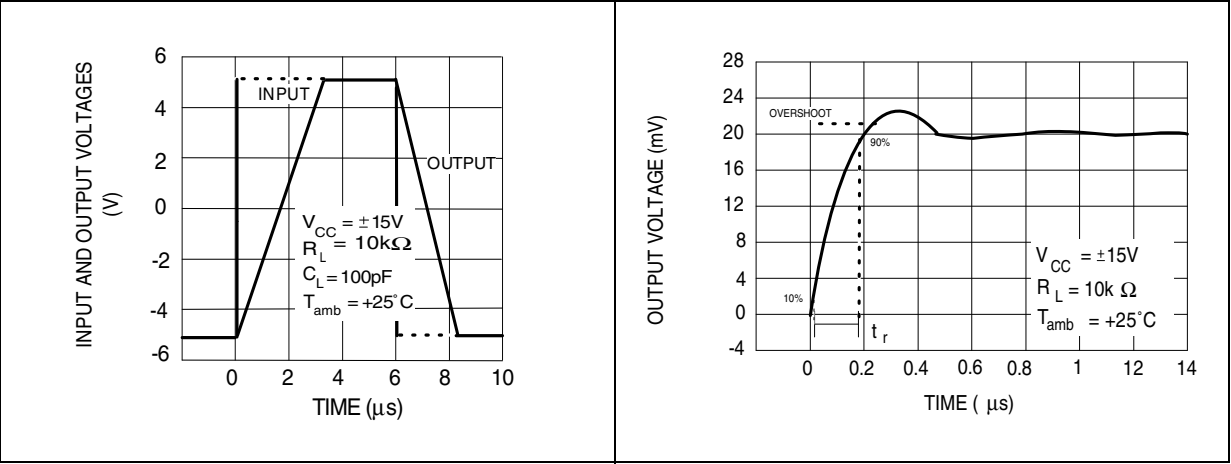
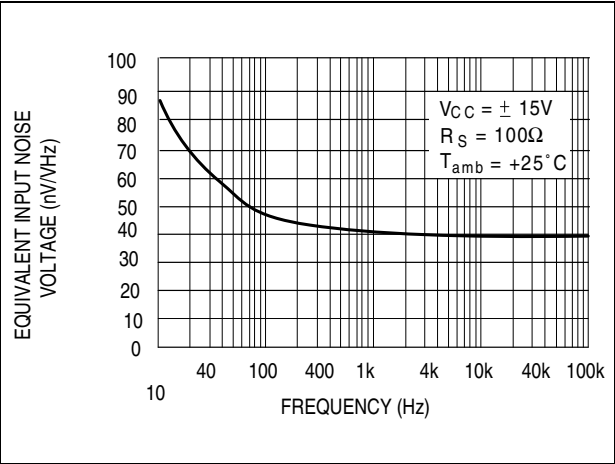
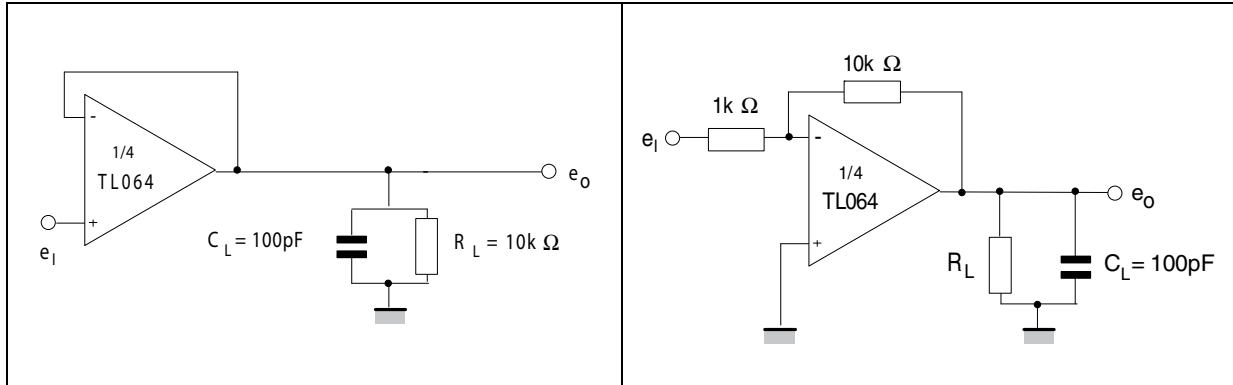


Figure 16. Equivalent input noise voltage versus frequency



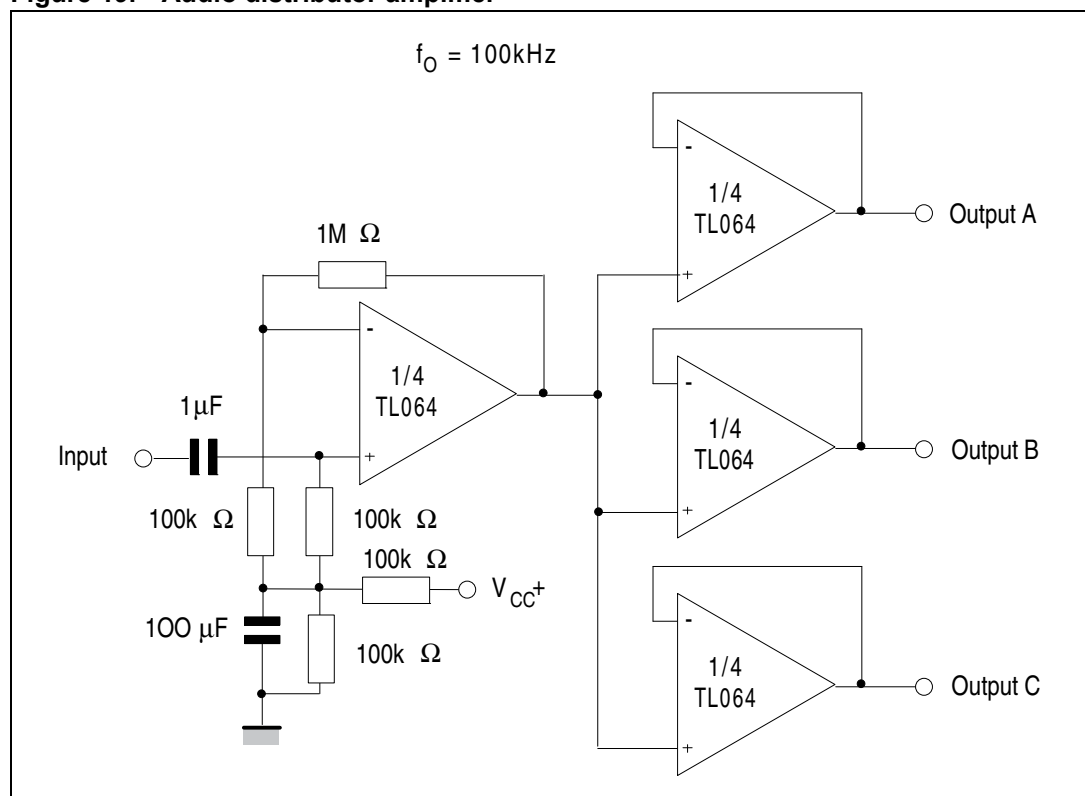
4 Parameter measurement information

Figure 18. Gain-of-10 inverting amplifier



5 Typical applications

Figure 19. Audio distributor amplifier



6 ECOPACK®

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

6.1 DIP14 package mechanical data

Figure 20. DIP14 package mechanical drawing

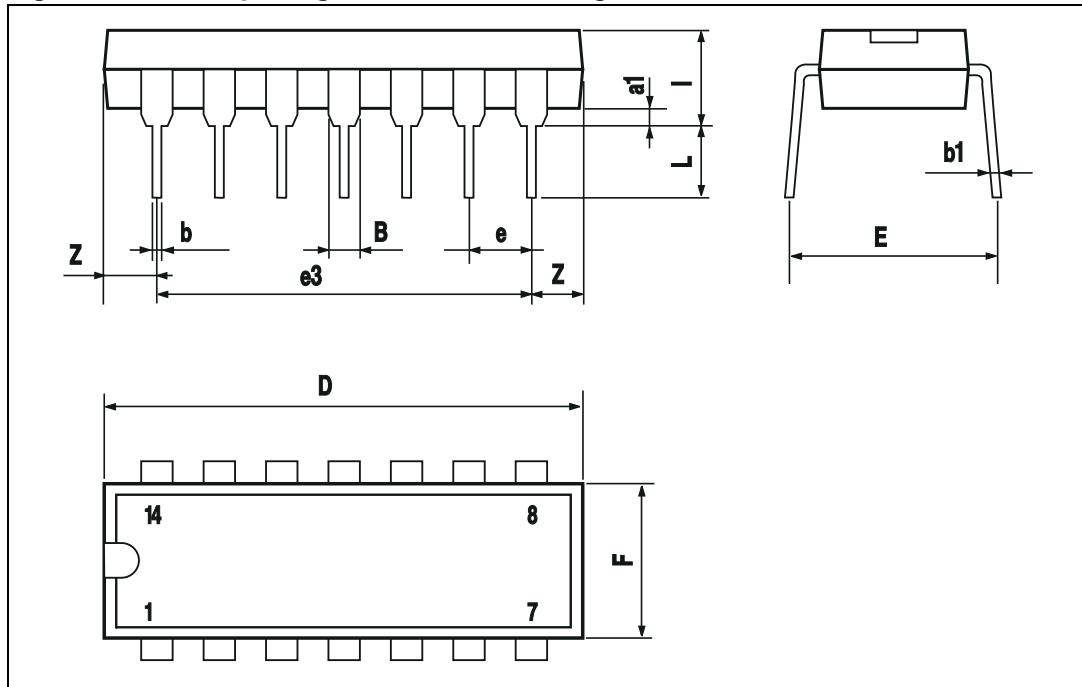


Table 5. DIP14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
a1	0.51			0.020		
B	1.39		1.65	0.055		0.065
b		0.50			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
e		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z	1.27		2.54	0.050		0.100

6.2 SO-14 package mechanical data

Figure 21. SO-14 package mechanical drawing

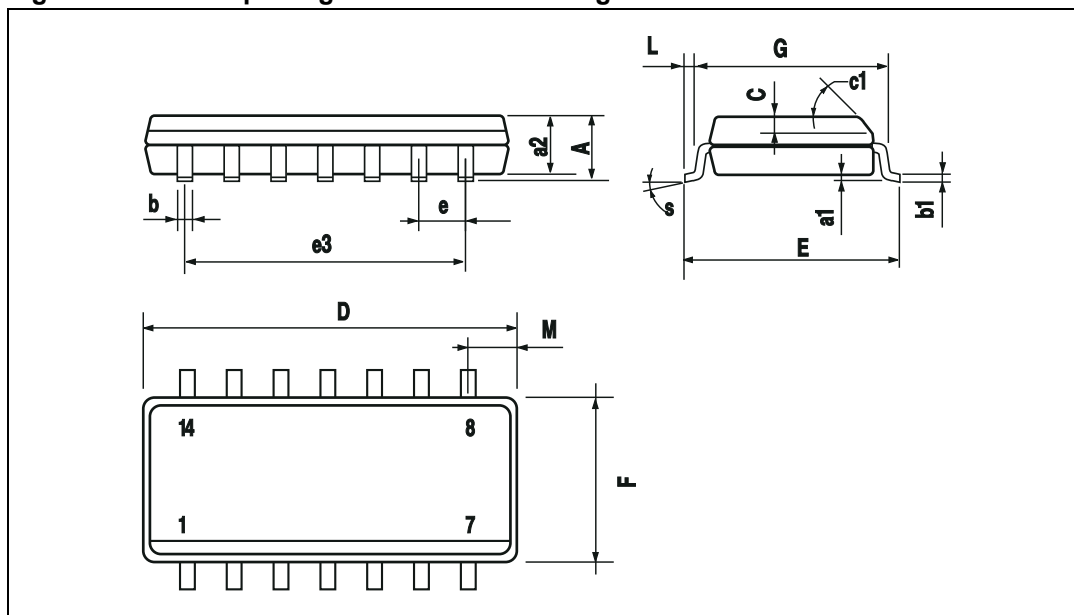


Table 6. SO-14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.068
a1	0.10		0.20	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.50			0.019	
c1	45° (typ.)					
D	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.50		1.27	0.019		0.050
M			0.68			0.026
S	8° (max.)					

7 Ordering information

Table 7. Order codes

Part number	Temperature range	Package	Packing	Marking
TL064MN	-55°C, +125°C	DIP14	Tube	TL064MN
TL064AMN				TL064AMN
TL064BMN				TL064BMN
TL064MD/DT		SO-14	Tube or tape & reel	064M
TL064AMD/DT				064AM
TL064BMD/DT				064BM
TL064IN	-40°C, +105°C	DIP14	Tube	TL064IN
TL064AIN				TL064AIN
TL064BIN				TL064BIN
TL064ID/DT		SO-14	Tube or tape & reel	064I
TL064AID/DT				064AI
TL064BID/DT				064BI
TL064CN	0°C, +70°C	DIP14	Tube	TL064CN
TL064ACN				TL064ACN
TL064BCN				TL064BCN
TL064CD/DT		SO-14	Tube or tape & reel	064C
TL064ACD/DT				064AC
TL064BCD/DT				064BC

8 Revision history

Table 8. Document revision history

Date	Revision	Changes
13-Nov-2001	1	Initial release.
25-Jul-2007	2	Added R_{thja} , R_{thjc} and ESD values in Table 1: Absolute maximum ratings . Added Table 2: Operating conditions . Expanded Table 7: Order codes . Format update.
09-Jan-2013	3	Updated Table 1: Absolute maximum ratings , Table 2: Operating conditions , Table 3: $V_{CC} = \pm 15\text{ V}$, $T_{amb} = +25^\circ\text{C}$ (unless otherwise specified) , Table 4: $V_{CC} = \pm 15\text{ V}$, $T_{amb} = +25^\circ\text{C}$ (unless otherwise specified) , and Table 7: Order codes . Replaced Figure 17: Voltage follower .

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